



Part Number:101-00364-**
SIM Card 8PIN Reverse W/O Switch

- Push-push eject type
- SMT
- Application for mobile phones

- 1.Materials:
 Housing: High temperature thermoplastic, UL 94V-0 rated.
 Contact: Copper alloy
 Cover: SUS304 with 80u" nickel over all, gold flash plating on contact area
- 2.Contact finish:
 Selective 15u" gold plating on contact area, tin 120u" plating at solder tail, over nickel plating (50U" min)
- 3.Electrical specifications:
 Voltage Rating: 100VAC
 Current Rating: 0.5A per contact
 Dielectric strength: 500VAC initial and 250VAC final for one minute
 Insulation Resistance: 500MΩ min at 500VDC
 Contact Resistance: 50mΩ max at 100mA
 Operating temperature: -25°C~+85°C
- 4.Mechanical specifications:
 Durability: 5000cycles.
 Mating force: 20N max.
 Unmating force: 1N min
- 5.RoHS Compliant

